

HIGHER EDUCATION SIG

COMPARATIVE & INTERNATIONAL EDUCATION SOCIETY

15 September 2009

Dear Higher Education SIG (HESIG) Members,

Greetings from Taiwan! I want to thank you for your continued commitment to one of the largest special interest groups (SIGs) in the Comparative and International Education Society (CIES). As you may or may not be aware, CIES determines the number of SIG-allotted panels or SIG-sponsored papers in its annual conferences based on the following two criteria: Annual SIG Fee submissions of \$10 and indicating you want your paper/panel to be part of a specific SIG. I want to encourage you to support the Higher Education SIG by (i) submitting your annual SIG fee, (ii) submitting papers and panels that can be sponsored by HESIG, and (iii) participating in the HESIG Business Meeting at next year's CIES Annual Conference in Chicago. For information on how to submit your annual SIG fee, please visit our website at: <http://www.higheredsig.org/membership.html>.

Along this vein, I encourage HESIG members to consider organizing HESIG-sponsored panels on a range of higher education topics. Some topics related to current higher education issues you may consider include Current Trends in Various Global Regions; Comparison Between Regions (e.g., Higher Education Research Comparisons between European and Pacific Rim Regions); Issues of Quality vs. Equity under a specific higher education context; International Higher Education Rankings vs. Traditional Higher Education Values and Academic Freedom; or another topic of your choice.

Higher education continues to be one of the most growing areas in comparative and international education, and I hope we can provide increasing evidence-based higher education research and discussion along with an in-depth ideas sharing and opinion exchanging during the forthcoming CIES Annual Meeting in Chicago. Please note the paper and panel submission deadline of 1 October 2009. For more information on submitting a paper or panel, please go to the following URL:

<http://cies2010.msu.edu/call-for-proposals.html>

I look forward to seeing each of you next year in Chicago.

All the best,



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